

PMEG100T20ELR-Q

100 V, 2 A low leakage current Trench MEGA Schottky barrier rectifier

12 July 2021

Product data sheet

1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP3 (SOD123W) small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low Q_{rr} and low I_{RM}
- · Low leakage current
- · High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High efficiency DC-to-DC conversion
- · Automotive LED lighting
- Switch mode power supply
- · Freewheeling applications
- Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 156 °C		-	-	2	Α
V_R	reverse voltage	T _j = 25 °C		-	-	100	V
V _F	forward voltage	I _F = 2 A; pulsed; T _j = 25 °C	[1]	-	705	800	mV
I _R	reverse current	V _R = 100 V; pulsed; T _j = 25 °C	[1]	-	0.15	1.25	μΑ
		V_R = 100 V; pulsed; T_j = 125 °C	[1]	-	0.28	1.2	mA

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		К .[К.] -А
2	А	anode	CFP3 (SOD123W)	sym001

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG100T20ELR-Q	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG100T20ELR-Q	LB

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	δ = 1; $T_{sp} \le 150 ^{\circ}\text{C}$		-	2.8	A
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 156 °C		-	2	A
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	50	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.68	W
			[2]	-	1.15	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

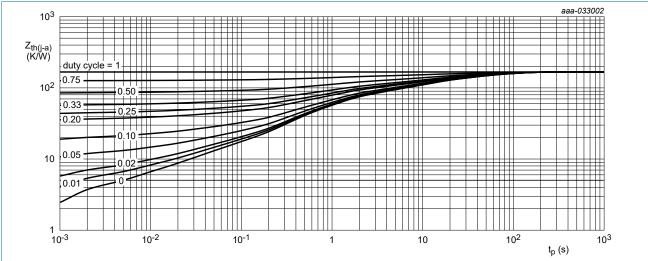
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

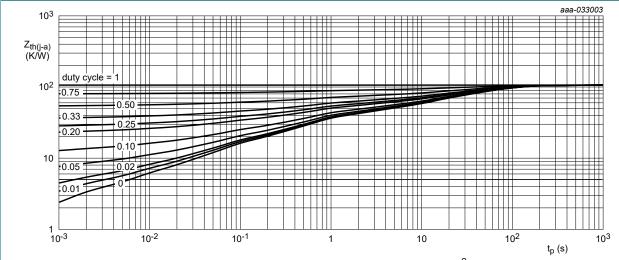
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	220	K/W
j	junction to ambient		[1] [3]	-	-	130	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]	-	-	18	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, single-sided copper, tin-plated and standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided copper, tin-plated and mounting pad for cathode 1 cm²

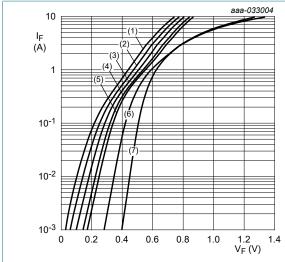
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I _R = 1 mA; T _j = 25 °C	[1]	100	-	-	V
V_{F}	forward voltage	I _F = 0.1 A; pulsed; T _j = 25 °C	[1]	-	420	490	mV
		I _F = 0.5 A; pulsed; T _j = 25 °C	[1]	-	515	580	mV
		I _F = 1 A; pulsed; T _j = 25 °C	[1]	-	590	660	mV
		I _F = 2 A; pulsed; T _j = 25 °C	[1]	-	705	800	mV
		I _F = 2 A; pulsed; T _j = -40 °C	[1]	-	705	800	mV
		I _F = 2 A; pulsed; T _j = 125 °C	[1]	-	590	660	mV
		I _F = 2 A; pulsed; T _j = 150 °C	[1]	-	550	620	mV
I _R	reverse current	V _R = 60 V; pulsed; T _j = 25 °C	[1]	-	0.06	0.5	μΑ
		V _R = 100 V; pulsed; T _j = 25 °C	[1]	-	0.15	1.25	μΑ
		V _R = 100 V; pulsed; T _j = 125 °C	[1]	-	0.28	1.2	mA
		V _R = 100 V; pulsed; T _j = 150 °C	[1]	-	1.1	5.5	mA
C _d	diode capacitance	$V_R = 1 \text{ V; } f = 1 \text{ MHz; } T_j = 25 \text{ °C}$		-	200	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	60	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $I_{j} = 25 \text{ °C}$		-	6	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	12	-	ns
I _{RM}	peak reverse recovery current	$dI_F/dt = 200 \text{ A/s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	1.3	-	Α
Q _{rr}	reverse recovery charge			-	8.5	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	520	-	mV

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) Tj = 175 °C

(2) Tj = 150 °C

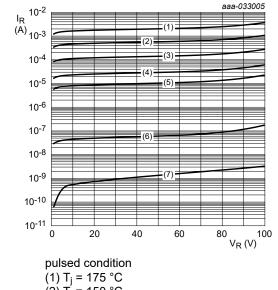
(3) Tj = 125 °C

(4) Tj = 100 °C (5) Tj = 85 °C

(6) Tj = 25 °C

(7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



(2) T_{i} = 150 °C

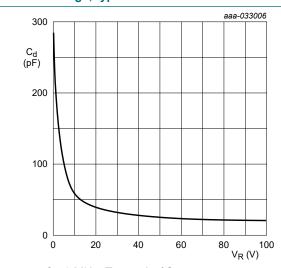
 $(3) T_i = 125 °C$

 $(4) T_j = 100 °C$

(5) $T_j = 85 ^{\circ}C$ (6) $T_i = 25 ^{\circ}C$

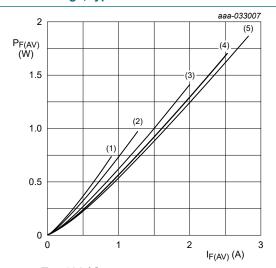
 $(7) T_i = -40 ^{\circ}C$

Fig. 4. Reverse current as a function of reverse voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ °C}$ Fig. 5. Diode capacitance as a function of reverse

voltage; typical values



 $T_j = 100 \, ^{\circ}C$

 $(1) \delta = 0.1$

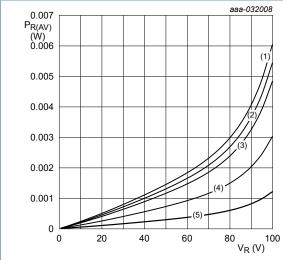
 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

(4) $\delta = 0.8$ (5) $\delta = 1$; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values

PMEG100T20ELR-Q



 $T_j = 100 \, ^{\circ}C$

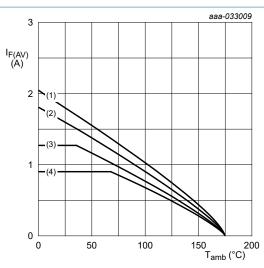
 $(1) \delta = 1$; DC

 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$ (5) $\delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

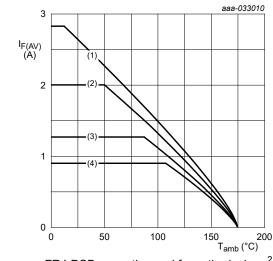
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

T_i = 175 °C

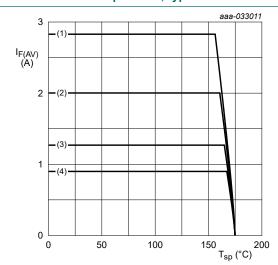
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

(1) δ = 1; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

6 / 14

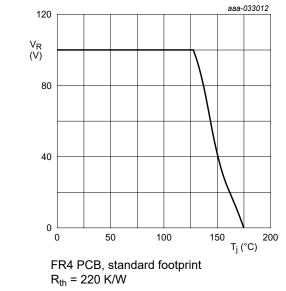
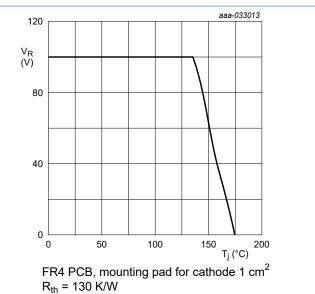
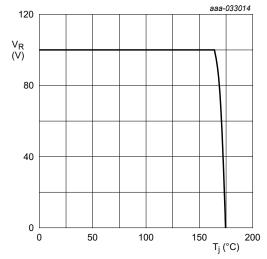


Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



of junction temperature; typical values



Soldering point of cathode tab $R_{th} = 18 \text{ K/W}$

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

11. Test information

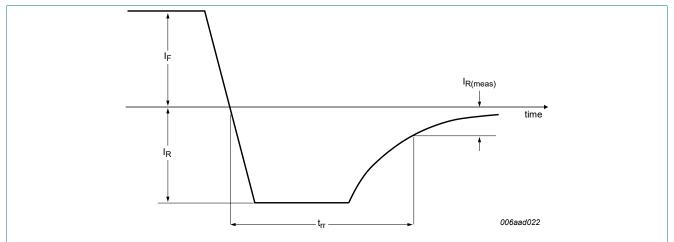


Fig. 14. Reverse recovery definition; step recovery

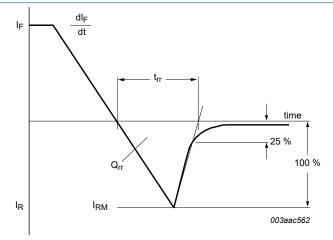


Fig. 15. Reverse recovery definition; ramp recovery

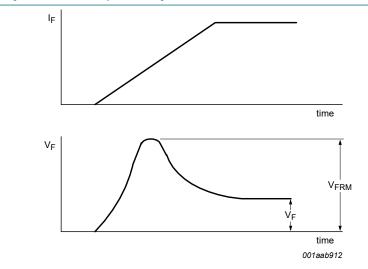
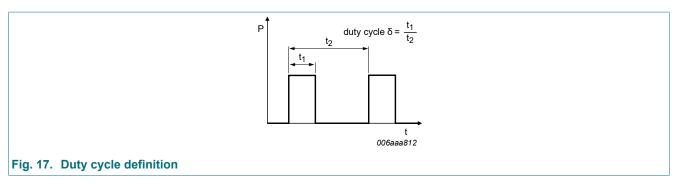


Fig. 16. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

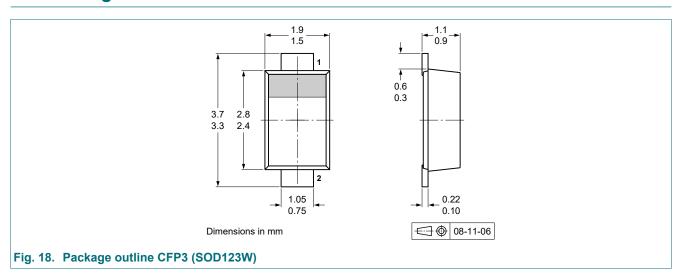
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_{M} \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

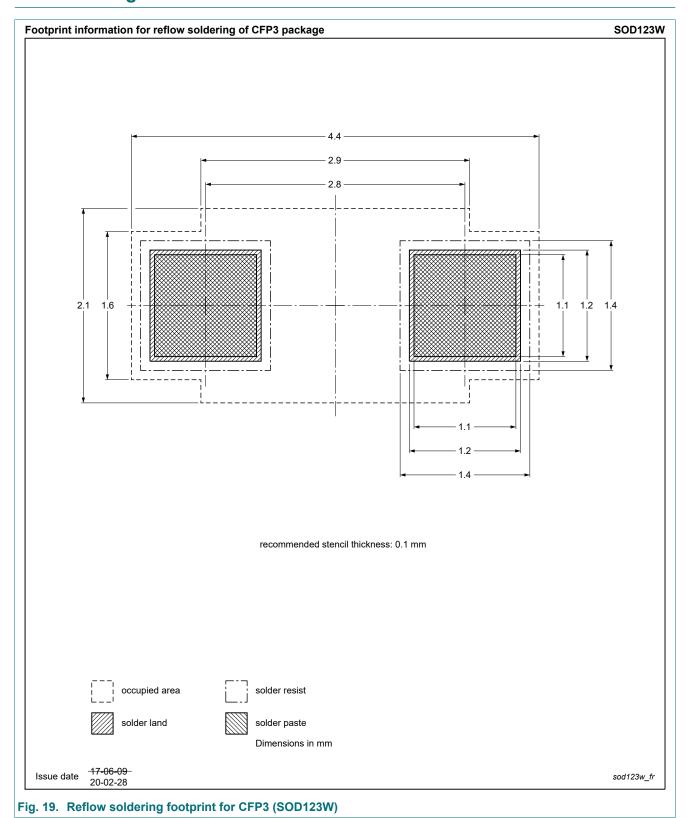
Quality information

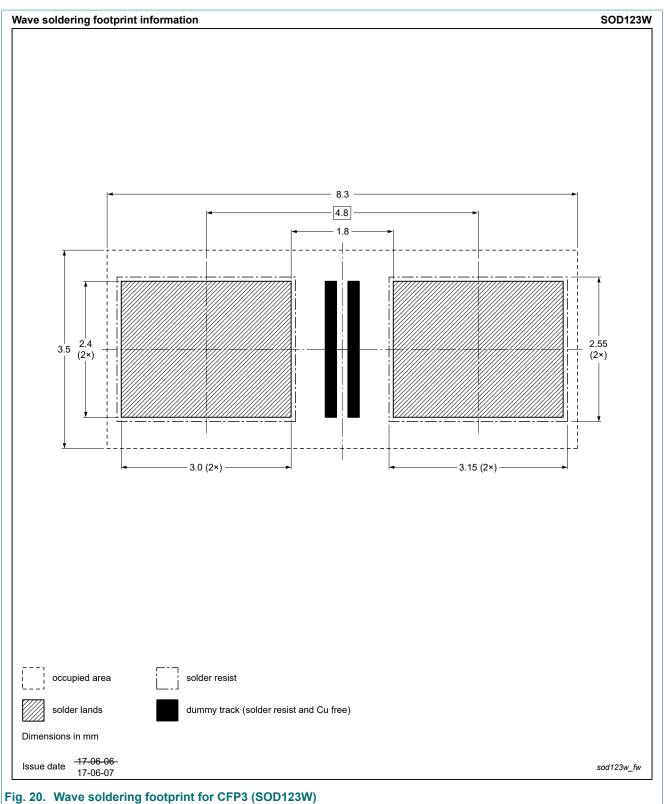
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





11 / 14

14. Revision history

Table 8. Revision history

Table 0. Kevision mistory				
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG100T20ELR-Q v.2	20210712	Product data sheet	-	PMEG100T20ELR-Q v.1
Modifications:	Figure 6 ada	pted		
PMEG100T20ELR-Q v.1	20210519	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	2
9.	Thermal characteristics	3
10	. Characteristics	4
11.	. Test information	8
12	. Package outline	9
	. Soldering	
	. Revision history	
	Legal information	
	-	

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